## 502630202 01/10/2014

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2676810

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
HONG SIK KIM	12/06/2013
HYUN JIN YOON	12/06/2013

#### RECEIVING PARTY DATA

Name:	LG ELECTRONICS INC.	
Street Address:	20 Yeouido-dong Yeongdeungpo-gu	
City:	Seoul	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	150-721	

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29478985

## CORRESPONDENCE DATA

 Fax Number:
 (202)739-3001

 Phone:
 2027393000

Email: adowney@morganlewis.com, patents@morganlewis.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: COLLIN PARK

Address Line 1: 1111 PENNSYLVANIA AVENUE NW

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20004

ATTORNEY DOCKET NUMBER:	001401-7116
NAME OF SUBMITTER:	ROBERT J. GOODELL
Signature:	/Robert J. Goodell/
Date:	01/10/2014

Total Attachments: 1

 $source = 001401-7116\_Assignment-01102014\#page1.tif$ 

PATENT REEL: 031941 FRAME: 0443

ATTORNEY DOCKET NO.: 041993-SOLE/JOINT INVENTION (U.S. Rights Only)

### ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

### **CASE FOR MOBILE PHONES**

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on \_\_\_\_, (Application No. \_\_\_); and

WHEREAS, LG ELECTRONICS INC., a corporation of the Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea, (hereinafter referred to as Assignce), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

and Power of Attorney in this application	and request the attorneys P we have en the insert here in parenthesis (Application ication number of said application when	on No. filed
IN TESTIMONY WHEREOF, L	WE have hereunto set our hand(s).	
Full Name of Sole or First Assignor Hong Sik KIM	Assignor's Signature	Date December 6, 2013
Address 19, Yangjae-daero 11-gil, Scocho-a	gu, Seoul, Korea	Citizenship Korean
full Name of Second Assignor Hyun Jin YOON	Assignor's Signature	Date December 6, 2013
Address 19, Yangjae-daero 11-gil, Seoche-g	ru, Seoul, Korea	Citizenship Korean
vames of additional inventors attached Y	es 🛮 No	

PATENT REEL: 031941 FRAME: 0444

RECORDED: 01/10/2014